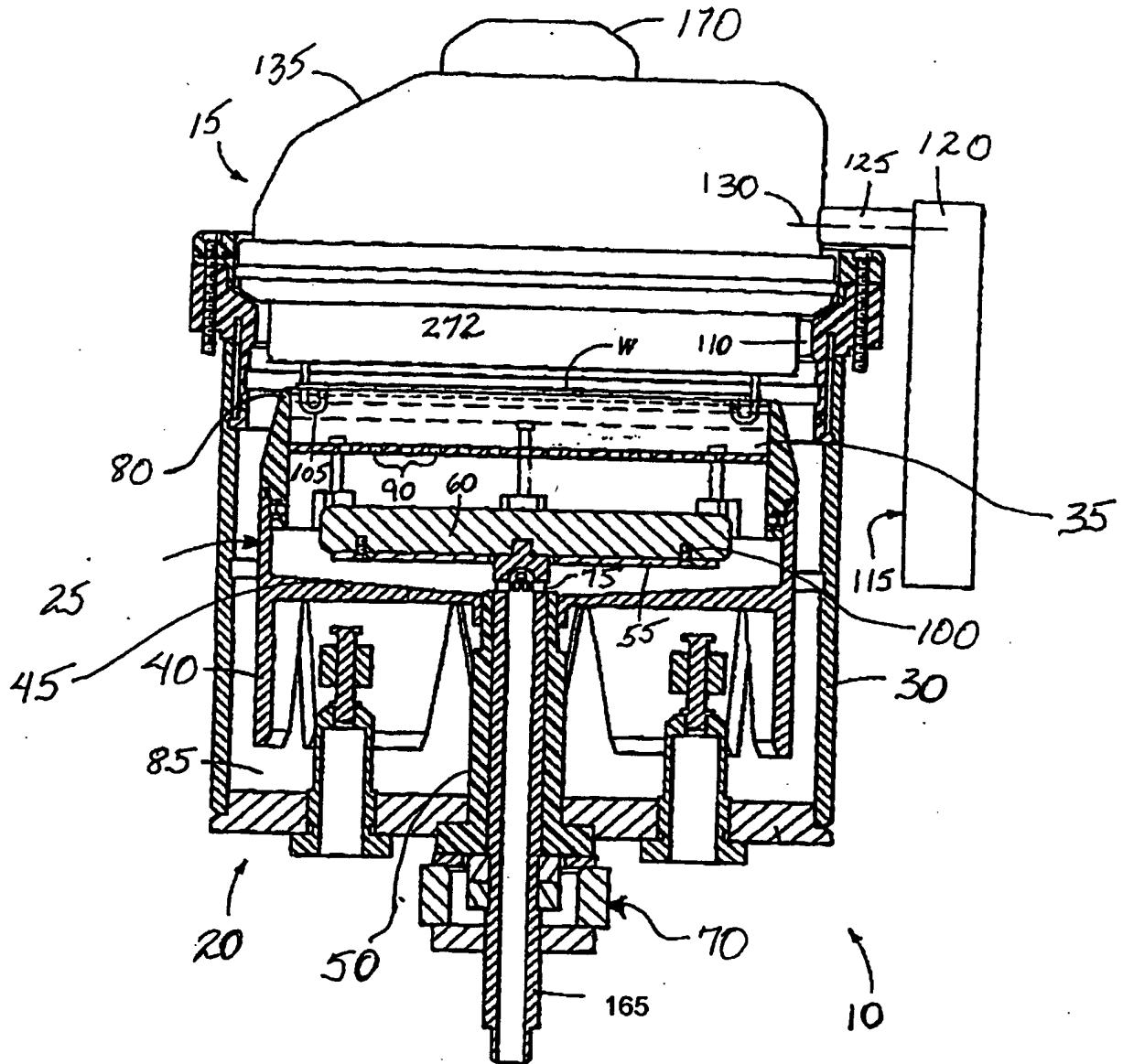


Title: METHOD FOR FILLING RECESSED MICRO-  
STRUCTURES WITH METALLIZATION IN THE  
PRODUCTION OF A MICROELECTRONIC DEVICE

Inventors: T.L. Ritzdorf et al.  
Docket No.: SEMT117192

FIG. 1



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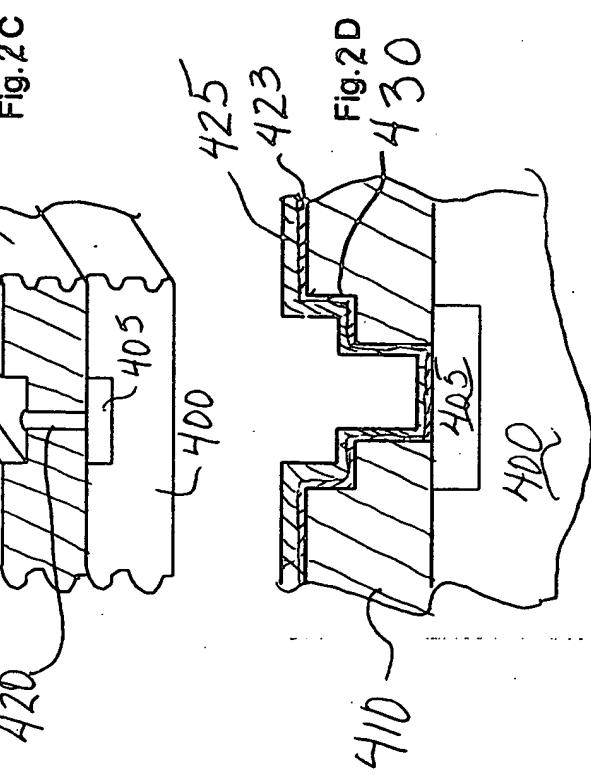
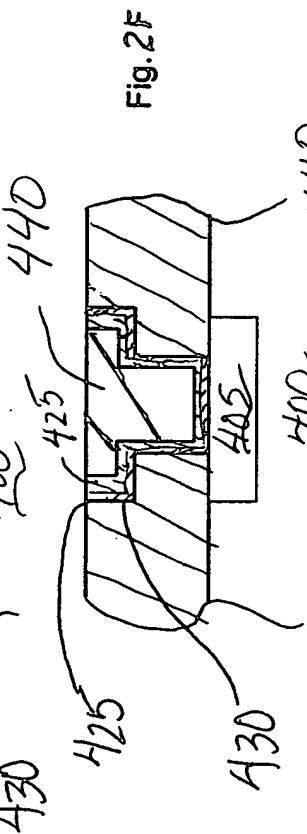
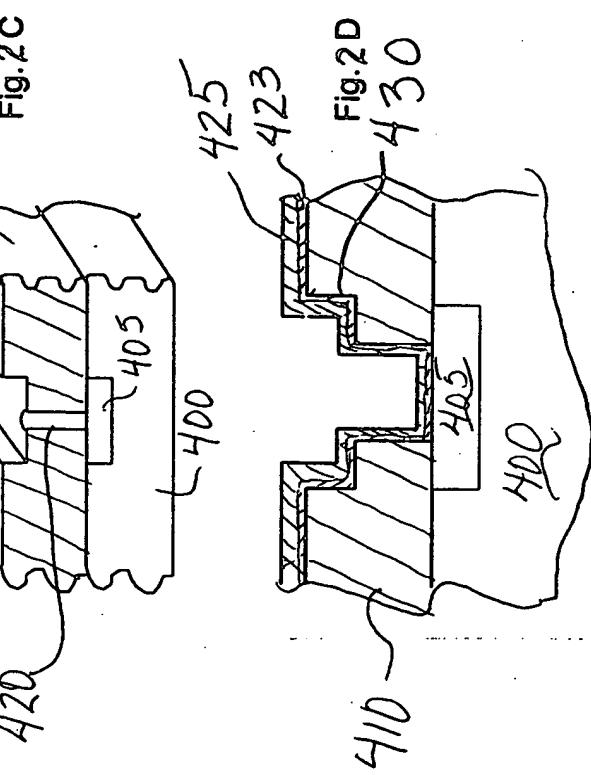
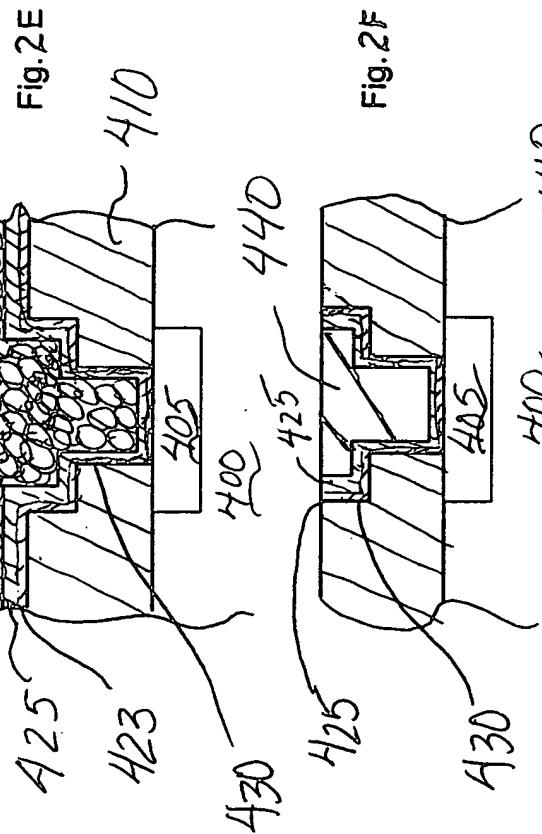
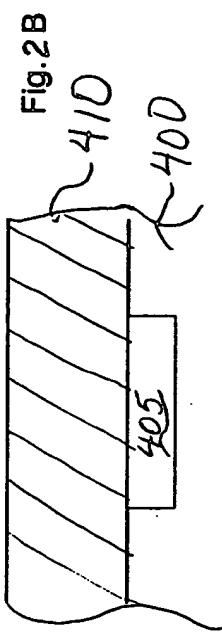
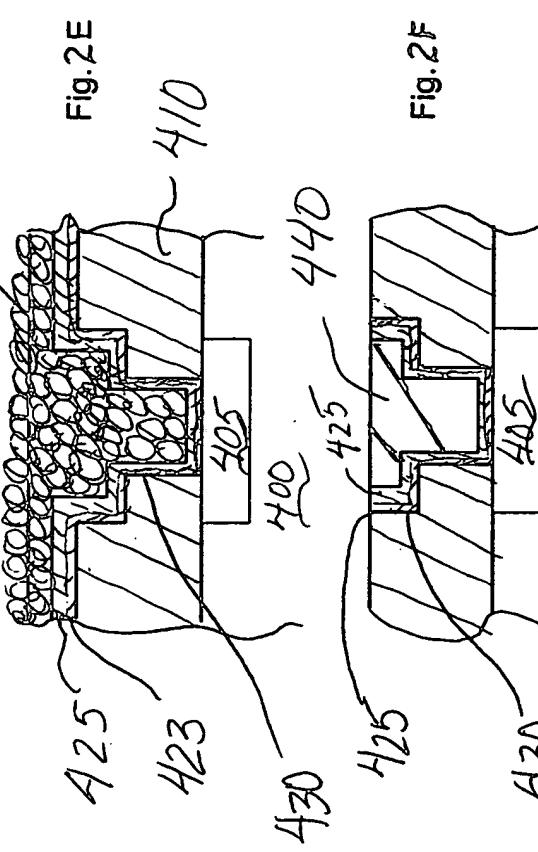
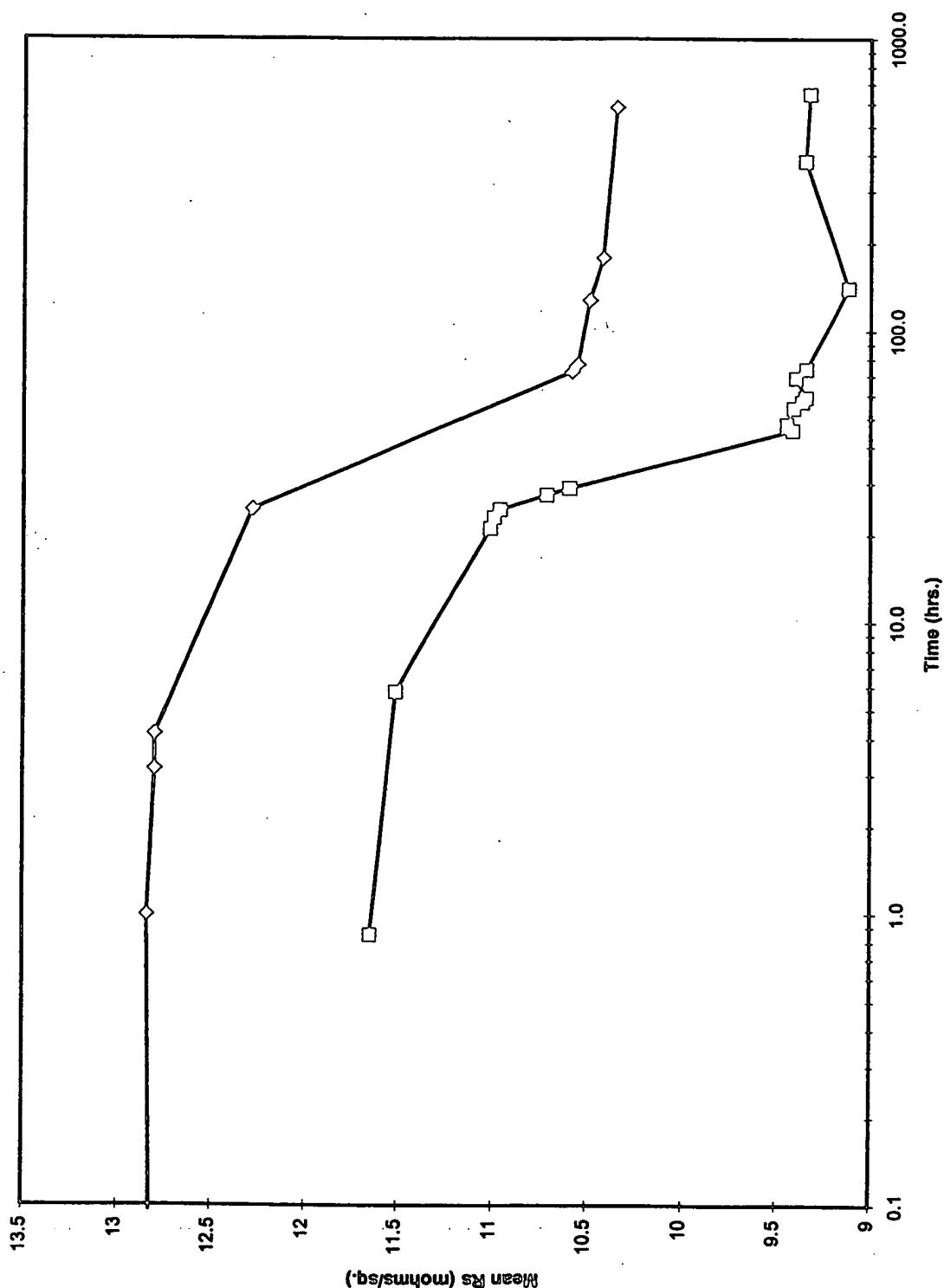


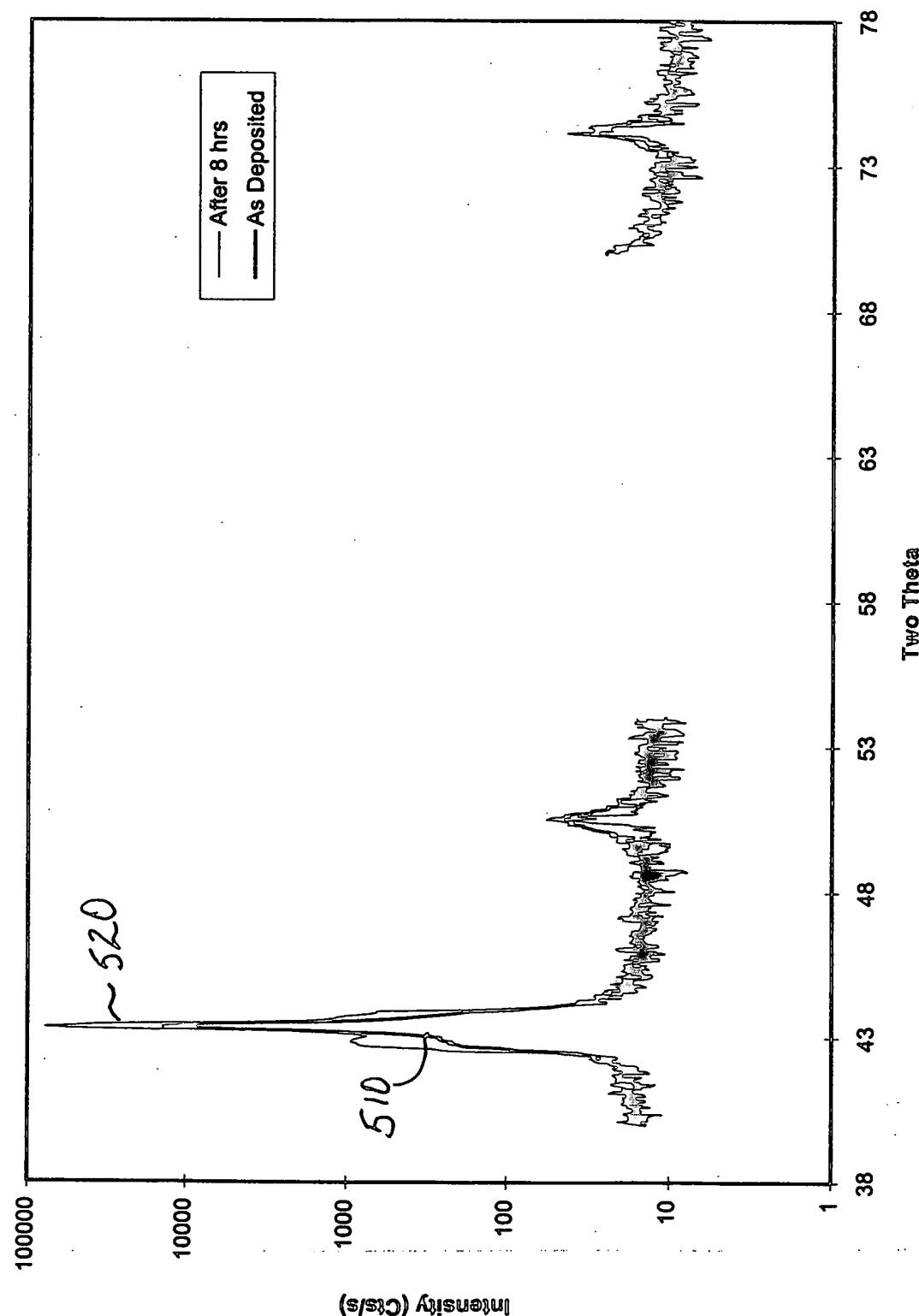
Fig. 3

Change in Mean Rs over Time



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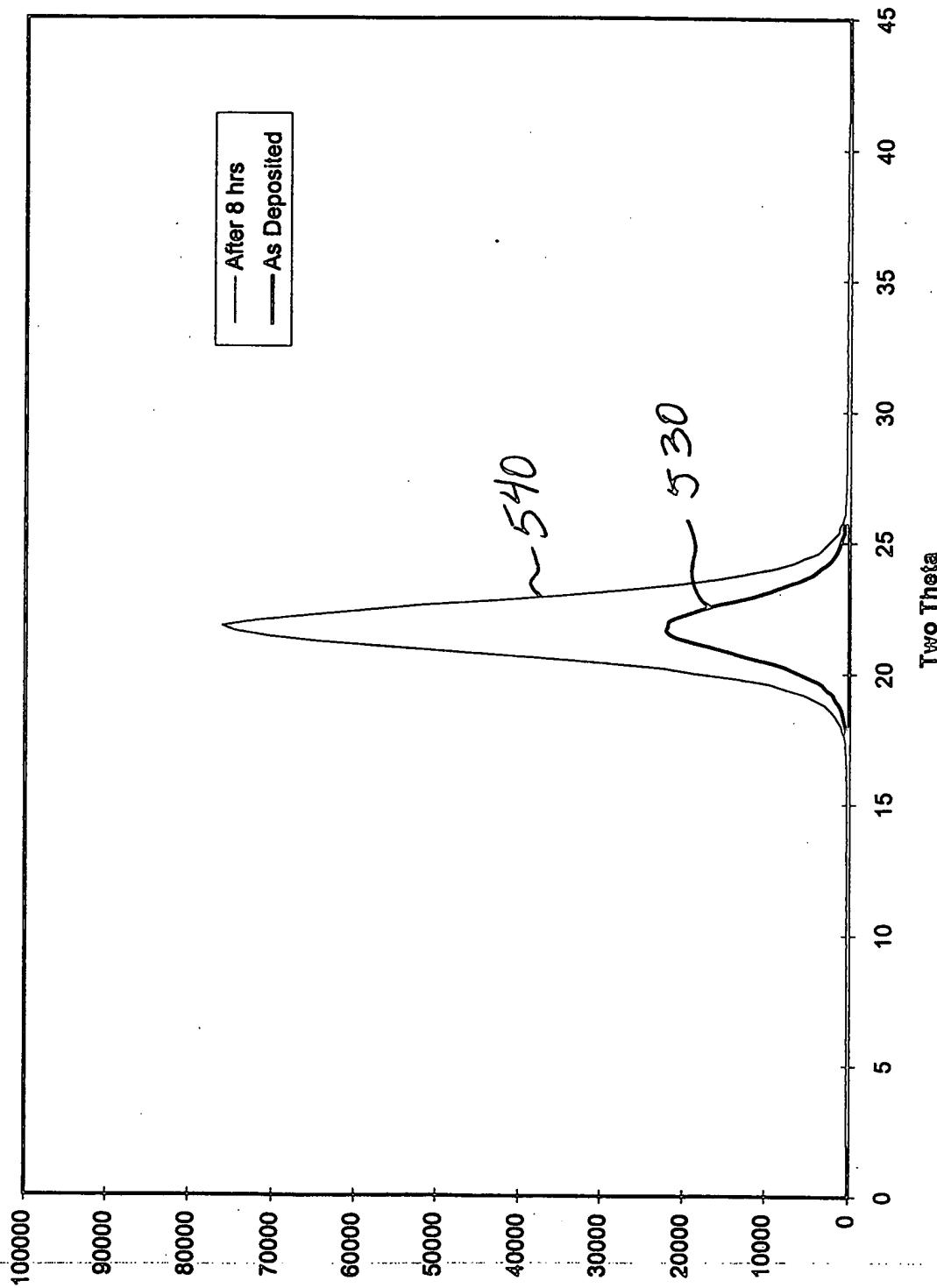
**Two Theta Coupled Scan**



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Fig. 5

Rocking Curve



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